

### SMD ■ Power Top LEDs 67-31E-SCC-7HBACAC1G-2T8-AM



#### Features

- P-LCC-3 package.
- Colorless clear resin.
- Wide viewing angle 120°.
- Inner reflector and white package.
- Brightness: 1800 to 3550 mcd at 50mA.
- Precondition: Bases on JEDEC J-STD 020D Level 3.
- Qualification according to AEC-Q101 rev C.
- Automotive reflow profile (IR reflow or wave soldering)

#### Applications

- Automotive backlighting : Interior and exterior automotive lighting(Dashboard backlighting, turn signal lamps, sidemakers, symbol and signal luminaire...etc.
- Backlight: LCD, switches, symbol, mobile phone and illuminated advertising.
- Display for indoor and outdoor application.
- Ideal for coupling into light guides.
- Substitution of traditional light.
- Optical indicator.
- General applications.

## Device Selection Guide

Chip Materials	Emitted Color	Resin Color
AlGaInP	Reddish Orange	Water Clear

## Absolute Maximum Ratings (Ta=25 °C)

Parameter	Symbol	Rating	Unit
Reverse Voltage	$V_R$	12	V
Forward Current	$I_F$	50	mA
Peak Forward Current (Duty 1/10 @1KHz)	$I_{FP}$	100	mA
Power Dissipation	$P_d$	120	mW
Junction Temperature	$T_j$	125	
Operating Temperature	$T_{opr}$	-40 ~ +100	
Storage Temperature	$T_{stg}$	-40 ~ +110	
Thermal resistance	$R_{th\ J-A}$	250	K/W
	$R_{th\ J-S}$	150	K/W
ESD (Classification acc. AEC Q101)	$ESD_{HBM}$	2000	V
	$ESD_{MM}$	200	V
Soldering Temperature	$T_{sol}$	Reflow Soldering : 260 for 30 sec. Hand Soldering : 350 for 3 sec.	

**Electro-Optical Characteristics (Ta=25 °C)**

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	$I_v$	1800	---	3550	mcd	$I_F = 50\text{mA}$
Viewing Angle	$2\theta_{1/2}$	---	120	---	deg	$I_F = 50\text{mA}$
Peak Wavelength	$\lambda_p$	---	621	---	nm	$I_F = 50\text{mA}$
Dominant Wavelength	$\lambda_d$	609	---	621	nm	$I_F = 50\text{mA}$
Spectrum Radiation Bandwidth	$\Delta\lambda$	---	18	---	nm	$I_F = 50\text{mA}$
Forward Voltage	$V_F$	1.7	---	2.6	V	$I_F = 50\text{mA}$
Reverse Current	$I_R$	---	---	10	$\mu\text{A}$	$V_R = 12\text{V}$

## Note:

1. Tolerance of Luminous Intensity:  $\pm 11\%$
2. Tolerance of Dominant Wavelength:  $\pm 1\text{nm}$
3. Tolerance of Forward Voltage:  $\pm 0.1\text{V}$

**Bin Range of Luminous Intensity**

Bin Code	Min.	Max.	Unit	Condition
BA	1800	2240	mcd	$I_F = 50\text{mA}$
BB	2240	2800		
CA	2800	3550		

## Note:

Tolerance of Luminous Intensity:  $\pm 11\%$

**Bin Range of Dominant Wavelength**

Bin Code	Min.	Max.	Unit	Condition
1	609	612	nm	I <sub>F</sub> =50mA
2	612	615		
3	615	618		
4	618	621		

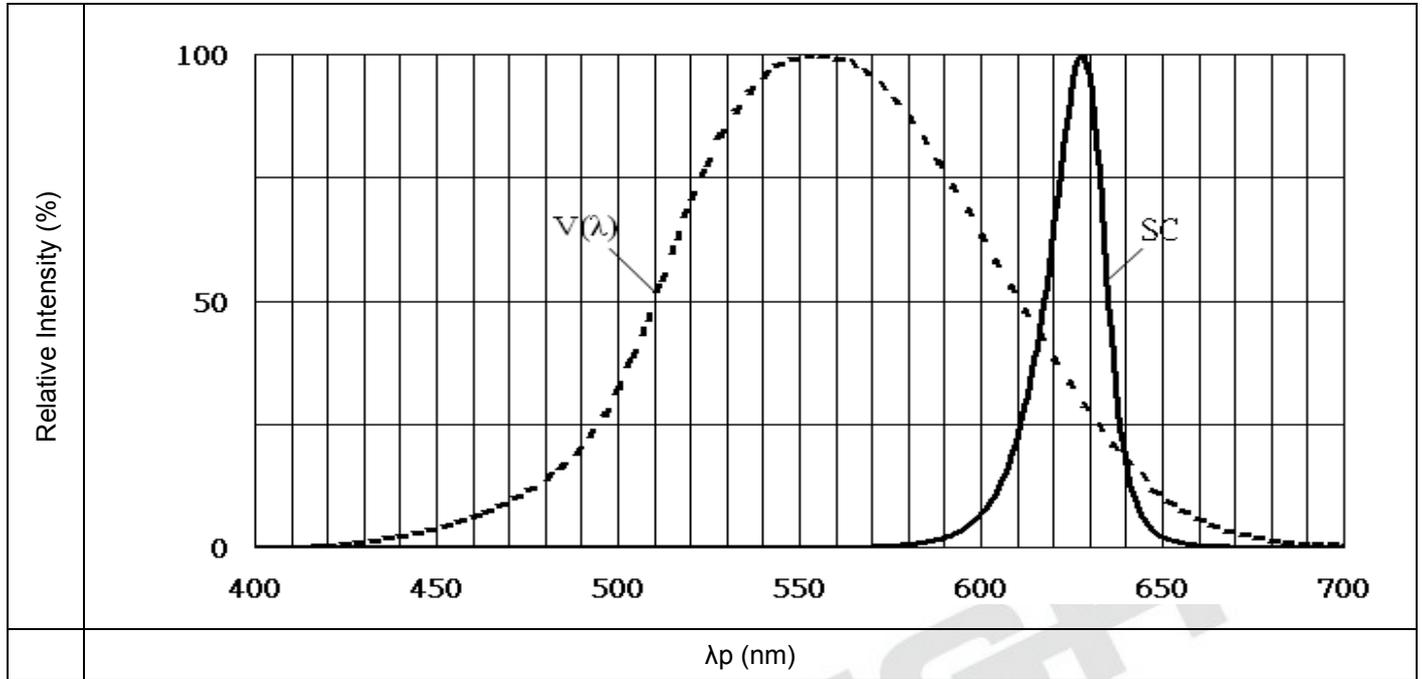
## Note:

Tolerance of Dominant Wavelength: ±1nm

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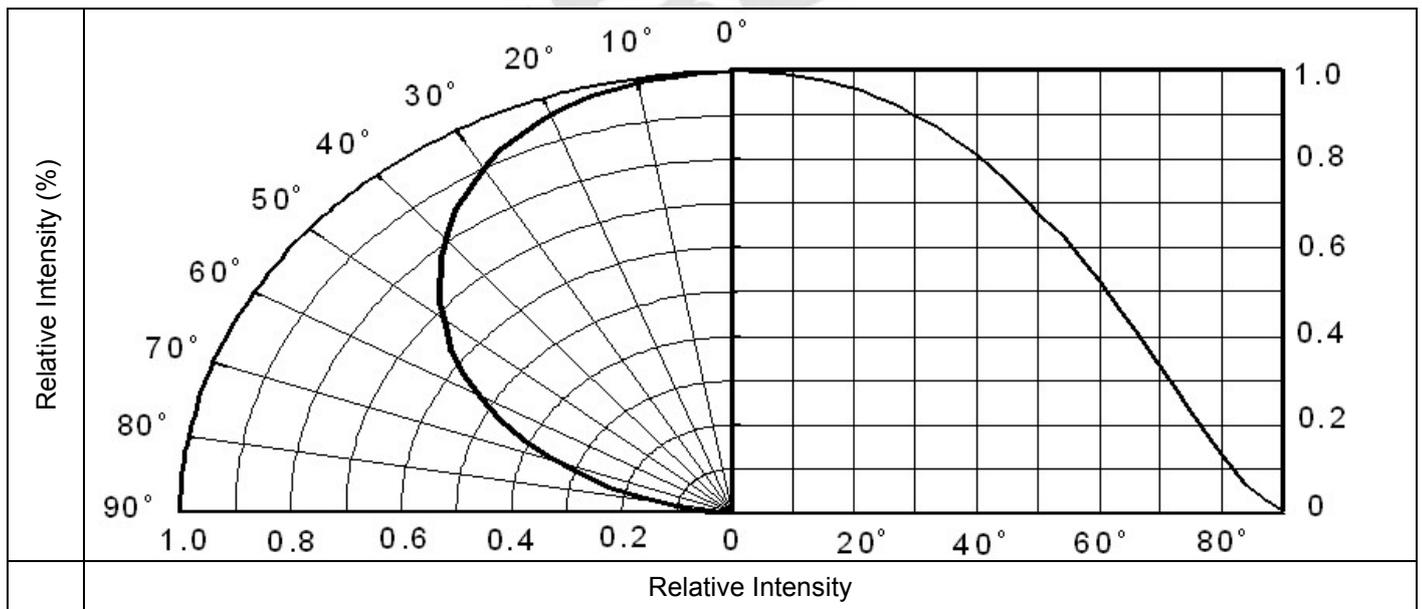
**Typical Electro-Optical Characteristics Curves**

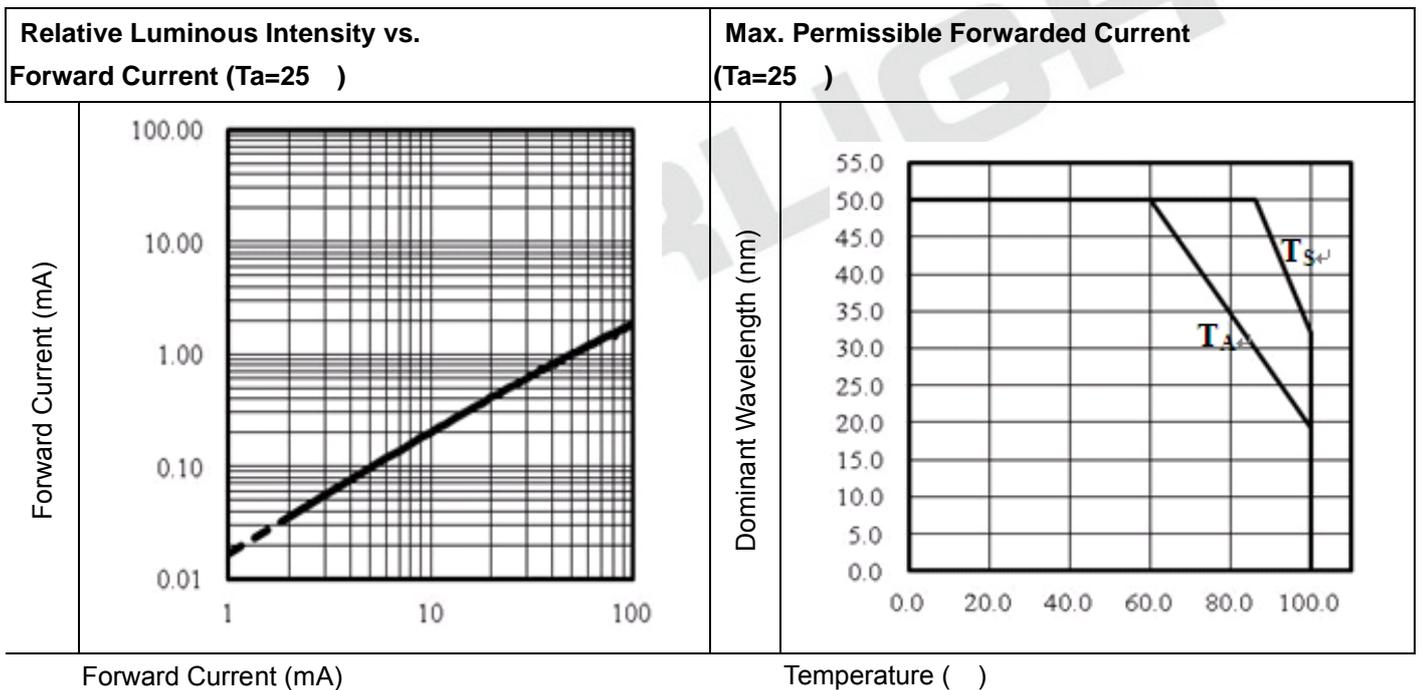
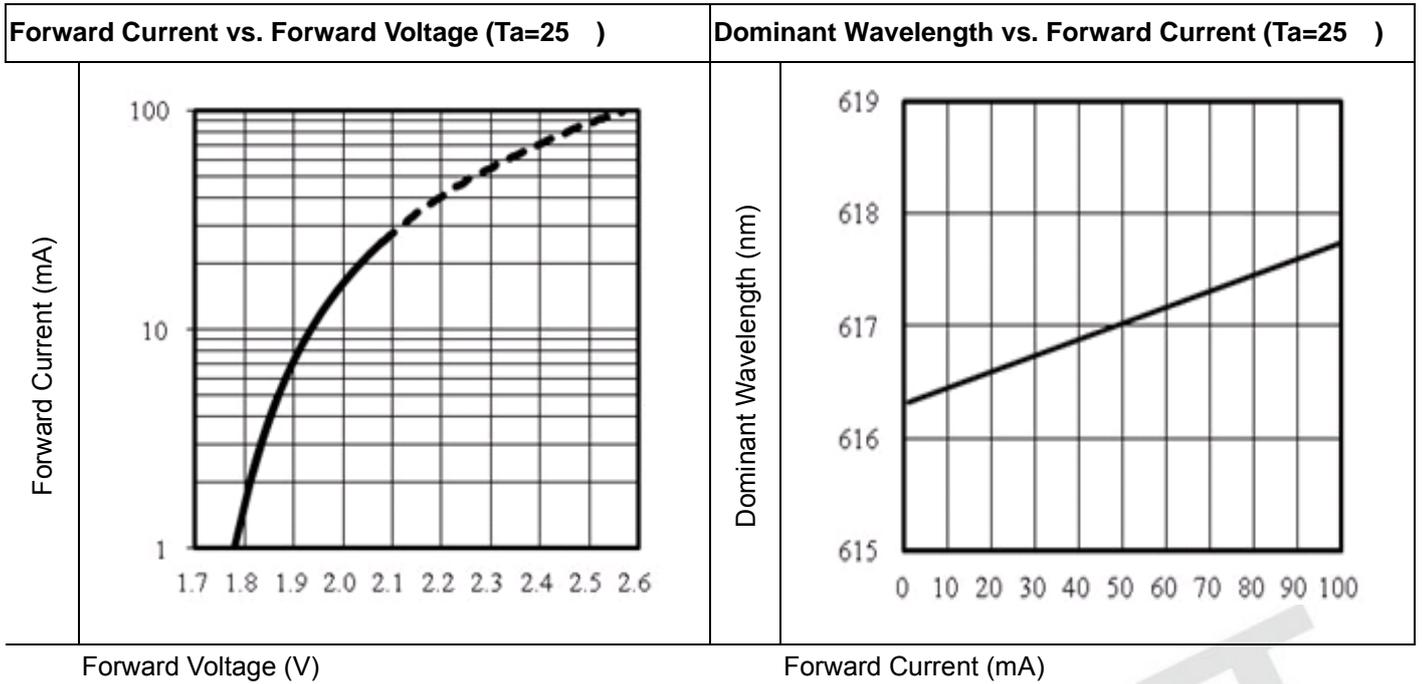
**Typical Curve of Spectral Distribution**



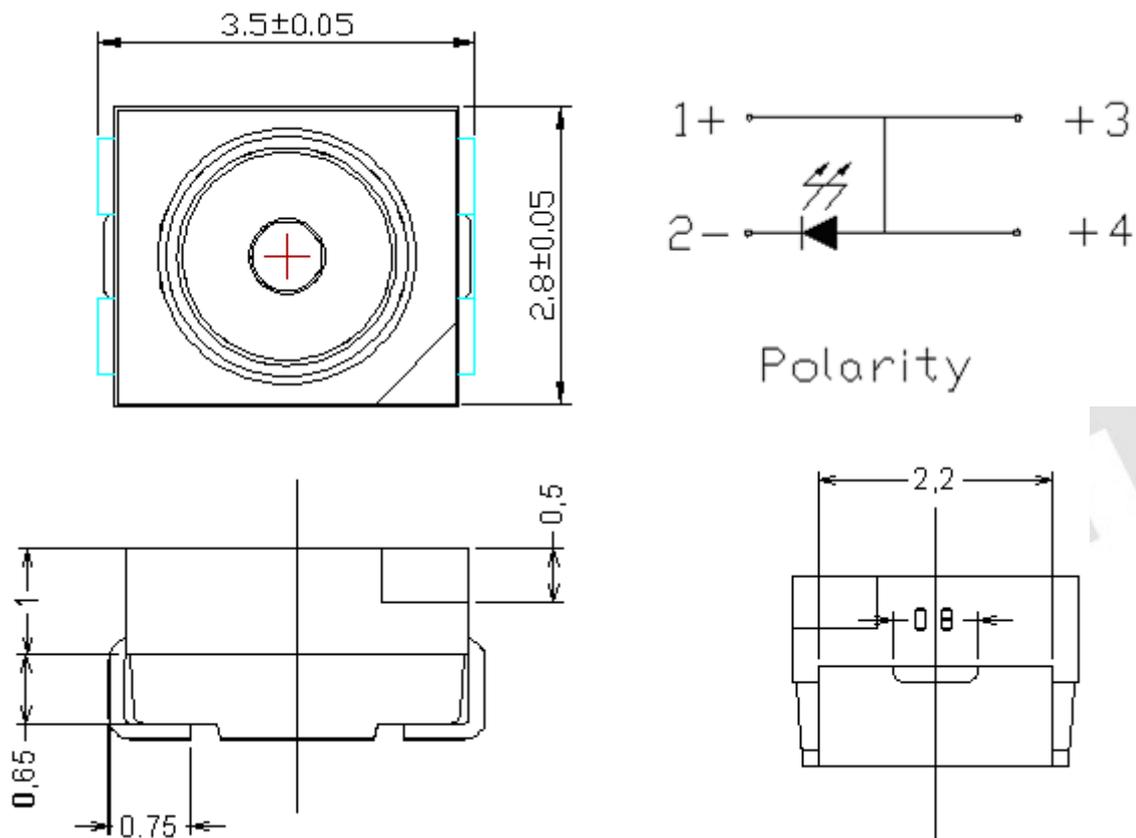
Note:  $V(\lambda)$ =Standard eye response curve;  $I_F = 20\text{mA}$

**Diagram Characteristics of Radiation**





Package Dimension



Polarity

Note: Tolerances unless mentioned  $\pm 0.1$ mm. Unit = mm

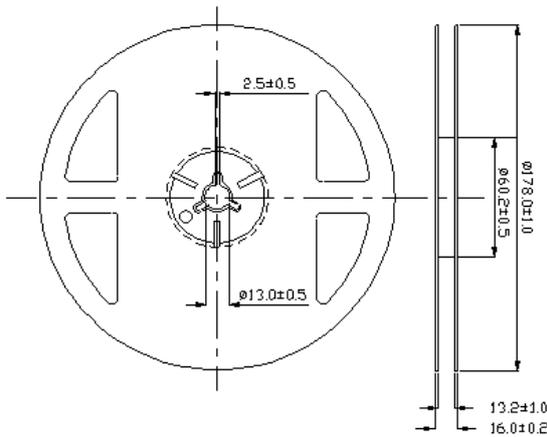
**Moisture Resistant Packing Materials**

**Label Explanation**

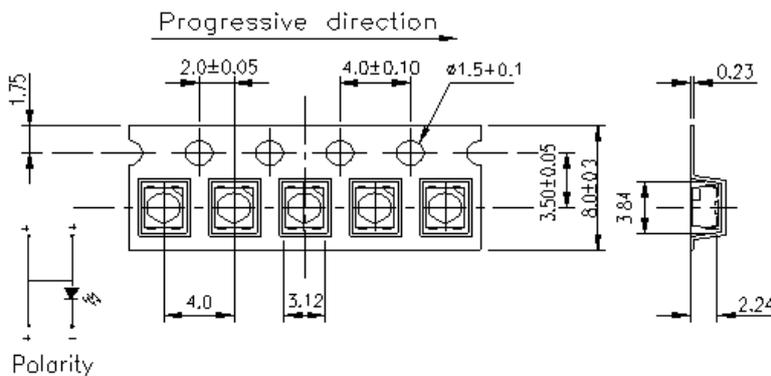


- CPN: Customer's Product Number
- P/N: Product Number
- QTY: Packing Quantity
- CAT: Luminous Intensity Rank
- HUE: Dom. Wavelength Rank
- REF: Forward Voltage Rank
- LOT No: Lot Number

**Reel Dimensions**

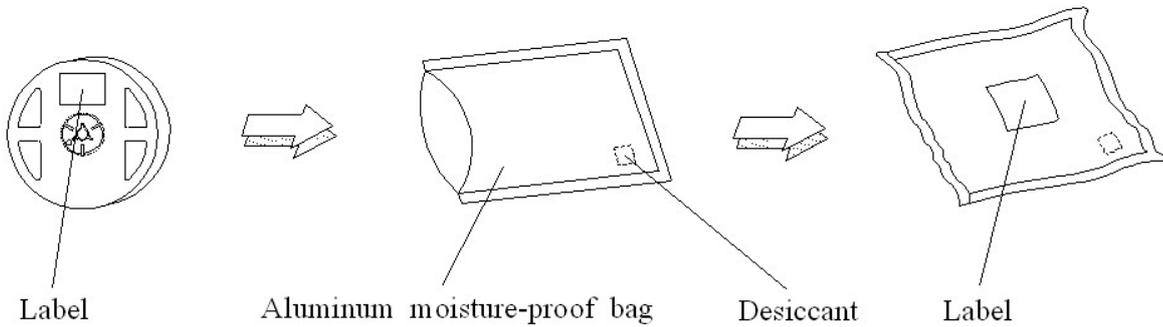


**Carrier Tape Dimensions: Loaded Quantity 2000 pcs Per Reel**



Note: Tolerances unless mentioned ±0.1mm. Unit = mm

**Moisture Resistant Packing Process**

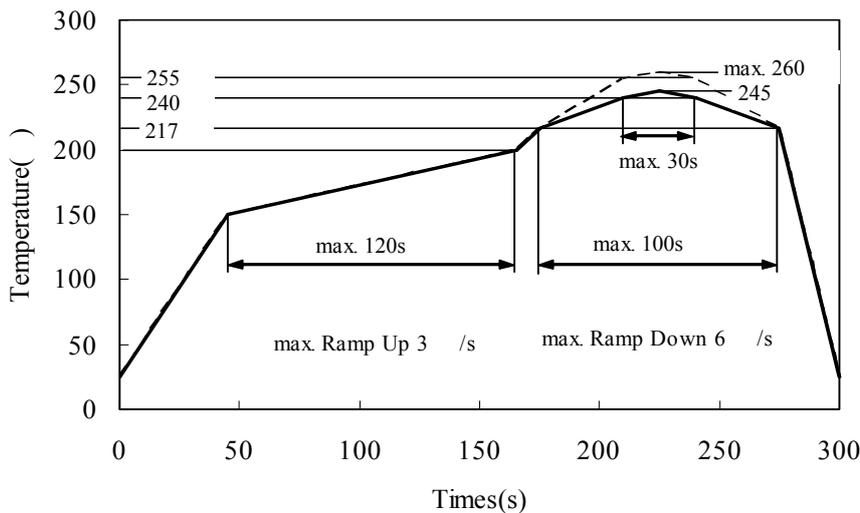


Note: Tolerances unless mentioned  $\pm 0.1\text{mm}$ . Unit = mm

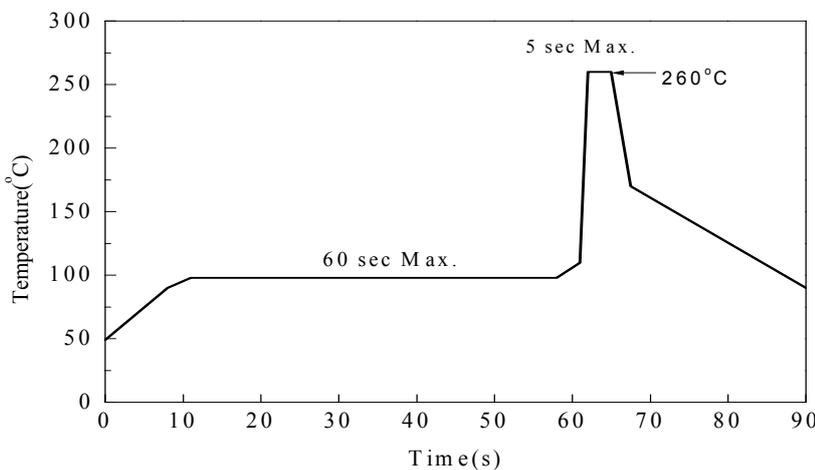
**Precautions for Use**

**1. Soldering Condition (Reference: IPC/JEDEC J-STD-020D)**

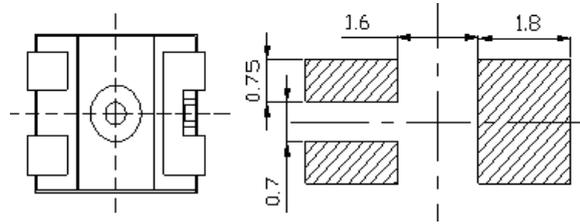
**a. IR reflow**



**b. Wave soldering reflow**



(B) Recommend soldering pad



Note: Tolerances unless mentioned  $\pm 0.1$ mm. Unit = mm

## 2. Current limiting

A resistor should be used to limit current spikes that can be caused by voltage fluctuations. Otherwise damage could occur.

## 3. Storage

3.1 Moisture proof bag should only be opened immediately prior to usage.

3.2 Environment should be less than 30 °C and 60% RH when moisture proof bag is opened.

3.3 After opening the package MSL Conditions stated on page 1 of this spec should not be exceeded.

3.4 If the moisture sensitivity card indicates higher than acceptable moisture, the component should be baked at min. 60deg  $\pm 5$ deg for 24 hours.

## 4. Iron Soldering

Hand soldering is not recommended for regular production. These guidelines are for rework only. Soldering iron tip should contact each terminal no more than 3 sec at 350 °C, using soldering iron with nominal power less than 25W. Allow min. 2 sec. between soldering intervals.

## 5. Usage

Do not exceed the values given in this specification.

## Application Restrictions

High reliability applications such as military/aerospace, automotive safety/security systems, and medical equipment may require different product. If you have any concerns, please contact Everlight before using this product in your application. This specification guarantees the quality and performance of the product as an individual component. Do not use this product beyond the specification described in this document.